

TELID[®] 281.3D-A preliminary

RFID vibration 3D sensor transponder

- passive sensor device
- 3D vibration measurement 0...200 Hz, up to +/- 8 g
- small size half lens plastic package D15 mm or on metal type Q16 package
- contactless data communication based on ISO14443B

RFID Sensor TELID[®] devices are an integral part of *microsensys* iID[®] system solution. These devices are very useful for wireless sensors applications in industrial solutions, for quality check in food and pharma industry, for temperature check in maintenance processes and transport and logistics. TELIDs are operating optimal with microsensys standard RFID reader.



TELID281A-02 preli

RFID Technology: Chip Type: Carrier Frequency: Communication Distance:	RFID syst	em iID [®] 300 iID-L 13.56 MH 0 20 m	00 Iz m	closed coup Commu depending on reade	bling, 13.56 MHz, based on ISO 144 nication Rate: 106 k r antenna and environmental condit	43B (bps ions
Object Data Memory: Static Memory: Free Memory:	EEPROM read write type endurance >100.000 cycles, data retention > 10 year 128bit, parameters, calibration and UID 128bit					
Acceleration Sensor: Measure Range: Resolution: Sample Rate: Frequency Range: Sensitivity: Acceleration Data Memory:	MEMS sensor, 3D acceleration (x, y, z-axis) 0 g +/-2 g, +/-4 g, +/-8 g 8 bit max. 200 Hz (for 3 axis) 0 Hz 200 Hz programmable bandwidth 25 Hz, 50 Hz, 100 0.5 mg/Hz^-0.5 RAM				programma -3 dB, sin 100 Hz, 190 Hz by digital theore	able nus, filter tical
Samples: Resolution:		170 samp 8 bit	oles per axi	s (for 3 axis)		
Temperature Sensor: Working Temperature: Resolution: Thermal Time Constant:	semicond	uctor sens -30°C 0. 5 K approxima	or +95°C ately 1 min	Accurac	opti c y: +/- 0 mounted on ob	onal .5 K oject
Operating Modes: Measure Modes: Basic Functions: Parameters:	PASSIVE SENSOR ON LINE MEASUREMENT programming of sensor parameters and object data me start delay, sample time, filter limits, amount of sam calibration data (opt					nory bles, bnal)
Battery:	no battery	,				
Working Temperature: Storage Temperature:	-25°C +	recommended 2	:5°C			
Dimensions: Packaging: Marking: Weight:	D 15 mm², thickness 3 mm 16 x 16 x 3 mm³ C laser printed / paper print 0.5 g / 1.0g				D14 pack Q16 package, on metal plastic (bl d / paper printed, optional unique ID	age type ack))-No
Appropriate RFID Reader: Software:	PEN reader with M30 HEAD reader with RS232TTL, RS485 o special TELID application software for Windows				with RS232TTL, USB or Blueto RS485 or USB for industrial applica	ooth ition
Type : Package: Acceleration Sensor: Temperature Sensor:	12.281.10 no metal l 3 axis type not activa	0* D14 e A ted	12.281.54 on metal 3 axis typ not activa	10 mounting Q16 e A ted	*) in development	

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